

July 26, 2010

Obsolescence Notification No: 2802 Rev.A

Subject: Obsolescence of the DDR SDRAM Type 5, 256M Multi-Chip Packages (MCPs) products listed below

This is revision A to ACN 2802 originally distributed on July 14, 2010. It is being revised to correct the Potential Replacement Parts section. Please refer to the change in bold in ‘Potential Replacement Parts’.

Spansion LLC is announcing the obsolescence of DDR SDRAM Type 5, 256M, and all valid combinations of the Multi-Chip Packages (MCPs) products listed below. See below for details:

Product Identification:

S72NS512RE0KHFL00 / S72NS512RE0KHFL03 / S72NS512RE0AHGL00 / S72NS512RE0AHGL03
S72WS512RE0HH6GN0 / S72WS512RE0HH6GN3
S98MS512RE0HW0200

Package Types: NLC133, NSC133, RLD133, RLB133

Product Line: Wireless Business Unit

Reason for Obsolescence: These products are being removed from Spansion's portfolio due to Commercial Die used in the MCPs being obsoleted by the commercial die supplier.

Application Impact: All valid combinations of the products affected will no longer be offered.

Potential Replacement Parts:

S72WS512RE0HH6GN0/ S72WS512RE0HH6GN3
S72NS512RE0KHFL00 / S72NS512RE0KHFL03 / S72NS512RE0AHGL00 / S72NS512RE0AHGL03
S98MS512RE0HW0200

➔ **S72VS256RE0xxxx** (VS256R + 256 DDR, Sample availability – Q2, 2011)

Old Part Final Order Date: Aug 15th, 2010

Old Part Final Shipment Date: Feb 15th, 2011

Products Affected By This Obsolescence (part numbers):

S72NS512RE0KHFL00

S72WS512RE0HH6GN3

Even though the above date projections are based on the most current product development status information at the time this Obsolescence was issued, they are subject to change. For the latest schedule and any other information, please contact your local sales office or your local distributor.